



Material Content Data Sheet



Halogen-Free

Sales Product Name	IPS70R600P7S	Issued	25. June 2021
MA#	MA005558730		
Package	PG-TO251-3-343	Weight*	339.60 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	1.674	0.49	0.49	4929	4929
leadframe	inorganic material	phosphorus	7723-14-0	0.055	0.02		163	
	non noble metal	iron	7439-89-6	0.185	0.05		544	
	non noble metal	copper	7440-50-8	184.668	54.39	54.46	543785	544492
wire	non noble metal	aluminium	7429-90-5	0.530	0.16	0.16	1560	1560
encapsulation	organic material	carbon black	1333-86-4	0.729	0.21		2146	
	plastics	epoxy resin	-	19.679	5.79		57949	
	inorganic material	silicondioxide	60676-86-0	125.366	36.92	42.92	369158	429253
leadfinish	non noble metal	tin	7440-31-5	4.771	1.40	1.40	14048	14048
solder	non noble metal	tin	7440-31-5	0.039	0.01		114	
	noble metal	silver	7440-22-4	0.049	0.01		143	
	non noble metal	lead	7439-92-1	1.854	0.55	0.57	5461	5718
*deviation	< 10%	Sum in total:				100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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